

PSMN009-100B,118 Datasheet



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DiGi Electronics Part Number PSMN009-100B,118-DG

Manufacturer Nexperia USA Inc.

Manufacturer Product Number PSMN009-100B,118

Description MOSFET N-CH 100V 75A D2PAK

Detailed Description N-Channel 100 V 75A (Tc) 230W (Tc) Surface Mount

D2PAK



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Purchase and inquiry

| Manufacturer Product Number: | Manufacturer: |
|-----------------------------------------|-------------------------------------------|
| PSMN009-100B,118 | Nexperia USA Inc. |
| Series: | Product Status: |
| TrenchMOS™ | Active |
| FET Type: | Technology: |
| N-Channel | MOSFET (Metal Oxide) |
| Drain to Source Voltage (Vdss): | Current - Continuous Drain (Id) @ 25°C: |
| 100 V | 75A (Tc) |
| Drive Voltage (Max Rds On, Min Rds On): | Rds On (Max) @ Id, Vgs: |
| 10V | 8.8mOhm @ 25A, 10V |
| Vgs(th) (Max) @ Id: | Gate Charge (Qg) (Max) @ Vgs: |
| 4V @ 1mA | 156 nC @ 10 V |
| Vgs (Max): | Input Capacitance (Ciss) (Max) @ Vds: |
| ±20V | 8250 pF @ 25 V |
| FET Feature: | Power Dissipation (Max): |
| | 230W (Tc) |
| Operating Temperature: | Mounting Type: |
| -55°C ~ 175°C (TJ) | Surface Mount |
| Supplier Device Package: | Package / Case: |
| D2PAK | TO-263-3, D2PAK (2 Leads + Tab), TO-263AB |
| Base Product Number: | |
| PSMN009 | |

Environmental & Export classification

8541.29.0095

| RoHS Status: | Moisture Sensitivity Level (MSL): |
|------------------|-----------------------------------|
| ROHS3 Compliant | 1 (Unlimited) |
| REACH Status: | ECCN: |
| REACH Unaffected | EAR99 |
| HTSUS | |

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N-channel TrenchMOS SiliconMAX standard level FET

Rev. 02 — 6 July 2009

Product data sheet

1. Product profile

1.1 General description

SiliconMAX standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

- High frequency computer motherboard DC-to-DC convertors
- OR-ing applicationss

1.4 Quick reference data

Table 1. Quick reference

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| V_{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | - | 100 | V |
| I _D | drain current | T _{mb} = 25 °C; V _{GS} = 10 V; see <u>Figure 1</u> ; see <u>Figure 3</u> | - | - | 75 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | - | - | 230 | W |
| Dynamic | characteristics | | | | | |
| Q_{GD} | gate-drain charge | $V_{GS} = 10 \text{ V}; I_D = 75 \text{ A};$ $V_{DS} = 80 \text{ V}; T_j = 25 \text{ °C};$ see Figure 11 | - | 44 | - | nC |
| Static ch | aracteristics | | | | | |
| R _{DSon} | drain-source on-state resistance | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \underline{\text{Figure 9}};$ $\text{see } \underline{\text{Figure 10}}$ | - | 7.5 | 8.8 | mΩ |



2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|-----|--------------------|----------------------------------|
| 1 | G | gate | | | |
| 2 | D | drain | [1] | mb | D |
| 3 | S | source | | | $G \longrightarrow \overline{A}$ |
| mb | D | mounting base; connected to drain | | | mbb076 S |
| | | | | SOT404 (D2PAK) | |

^[1] It is not possible to make connection to pin 2.

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|--------------|---------|----------------------------------------------------------------------------------|---------|
| | Name | Description | Version |
| PSMN009-100B | D2PAK | plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped) | SOT404 |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|-----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|-----|-----|------|
| V_{DS} | drain-source voltage | $T_j \ge 25 ^{\circ}\text{C}; T_j \le 175 ^{\circ}\text{C}$ | - | 100 | V |
| V_{DGR} | drain-gate voltage | $T_j \le 175 \text{ °C}; T_j \ge 25 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$ | - | 100 | V |
| V_{GS} | gate-source voltage | | -20 | 20 | V |
| I _D | drain current | $V_{GS} = 10 \text{ V}; T_{mb} = 100 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{\text{Model}}$ | - | 65 | Α |
| | | $V_{GS} = 10 \text{ V}$; $T_{mb} = 25 \text{ °C}$; see <u>Figure 1</u> ; see <u>Figure 3</u> | - | 75 | Α |
| I_{DM} | peak drain current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see <u>Figure 3</u> | - | 400 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | - | 230 | W |
| T _{stg} | storage temperature | | -55 | 175 | °C |
| Tj | junction temperature | | -55 | 175 | °C |
| V_{GSM} | peak gate-source voltage | pulsed; $t_p \le 50 \ \mu s$; $T_j \le 150 \ ^{\circ}C$; $\delta = 25 \ \%$ | -30 | 30 | V |
| Source-dra | ain diode | | | | |
| I _S | source current | $T_{mb} = 25 ^{\circ}C$ | - | 75 | Α |
| I _{SM} | peak source current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$ | - | 400 | Α |
| Avalanche | ruggedness | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 35 A; V_{sup} = 15 V; unclamped; t_p = 0.1 ms; R_{GS} = 50 Ω | - | 120 | mJ |
| I _{DS(AL)S} | non-repetitive drain-source avalanche current | V_{GS} = 10 V; V_{sup} = 15 V; R_{GS} = 50 $\Omega;$ $T_{j(init)}$ = 25 °C; unclamped | - | 75 | A |

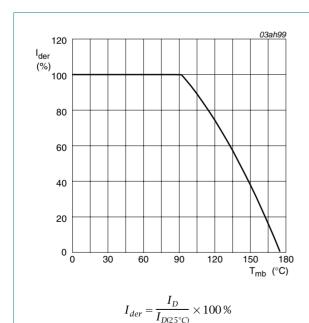


Fig 1. Normalized continuous drain current as a function of mounting base temperature

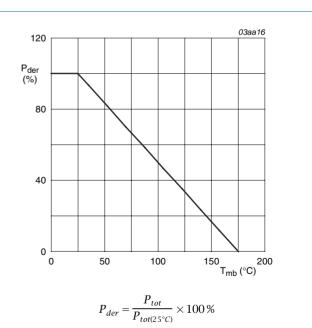
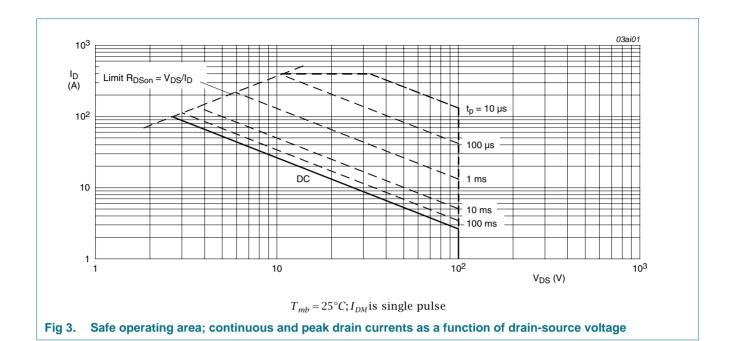


Fig 2. Normalized total power dissipation as a function of mounting base temperature



Thermal characteristics

Table 5. **Thermal characteristics**

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------------------|-------------------------------------------------------|-----|-----|------|------|
| $R_{th(j\text{-}mb)}$ | thermal resistance from junction to mounting base | see Figure 4 | - | - | 0.65 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | minimum footprint; mounted on a printed-circuit board | - | 50 | - | K/W |

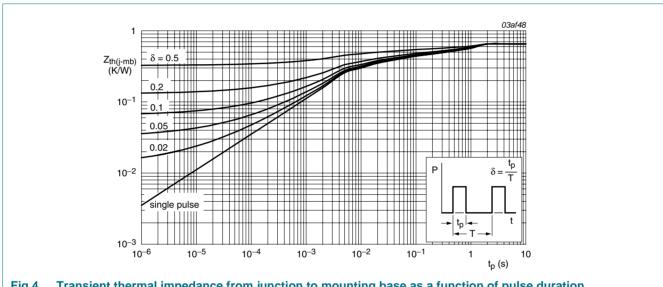


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

N-channel TrenchMOS SiliconMAX standard level FET

6. Characteristics

Table 6. Characteristics

| Table 6. | Characteristics | | | | | |
|---------------------|----------------------------------|--------------------------------------------------------------------------------------------------------|-----|-------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static cha | racteristics | | | | | |
| $V_{(BR)DSS}$ | drain-source | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$ | 90 | - | - | V |
| | breakdown voltage | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | 100 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 175 \text{ °C}$; see Figure 8 | 1 | - | - | V |
| | | $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ °C}$; see Figure 8 | 2 | 3 | 4 | V |
| | | I_D = 1 mA; V_{DS} = V_{GS} ; T_j = -55 °C; see <u>Figure 8</u> | - | - | 4.4 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$ | - | - | 500 | μΑ |
| | | $V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.02 | 1 | μΑ |
| I _{GSS} | gate leakage current | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 10 | 100 | nΑ |
| | | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 10 | 100 | nΑ |
| R_{DSon} | drain-source on-state resistance | V_{GS} = 10 V; I_D = 25 A; T_j = 175 °C; see <u>Figure 9</u> ; see <u>Figure 10</u> | - | 20.25 | 23.8 | mΩ |
| | | $V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 9; see Figure 10 | - | 7.5 | 8.8 | mΩ |
| Dynamic | characteristics | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 75 \text{ A}; V_{DS} = 80 \text{ V}; V_{GS} = 10 \text{ V};$ | - | 156 | - | nC |
| Q _{GS} | gate-source charge | T _j = 25 °C; see <u>Figure 11</u> | - | 31 | - | nC |
| Q_{GD} | gate-drain charge | | - | 44 | - | nC |
| C _{iss} | input capacitance | $V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ | - | 8250 | - | pF |
| C _{oss} | output capacitance | T _j = 25 °C; see <u>Figure 12</u> | - | 620 | - | pF |
| C _{rss} | reverse transfer capacitance | | - | 300 | - | pF |
| t _{d(on)} | turn-on delay time | $V_{DS} = 15 \text{ V}; R_L = 1.25 \Omega; V_{GS} = 10 \text{ V};$ | - | 38 | - | ns |
| t _r | rise time | $R_{G(ext)} = 6 \Omega; T_j = 25 \text{ °C}; I_D = 12 A$ | - | 59 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 120 | - | ns |
| t _f | fall time | | - | 43 | - | ns |
| Source-di | rain diode | | | | | |
| V_{SD} | source-drain voltage | $I_S = 25 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ °C}$; see Figure 13 | - | 0.8 | 1.2 | V |

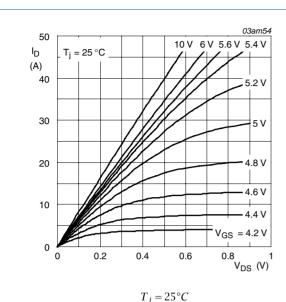
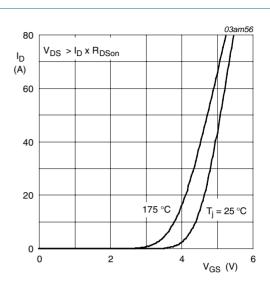
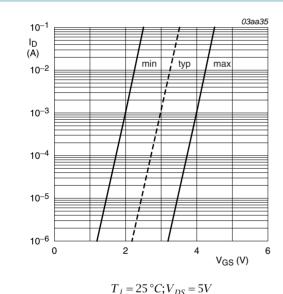


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



 $T_i = 25$ °C and 175°C; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values



Sub-threshold drain current as a function of gate-source voltage

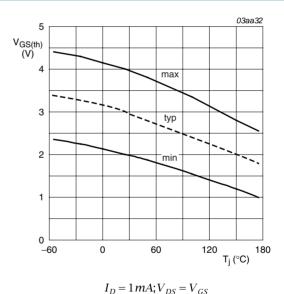


Fig 8. Gate-source threshold voltage as a function of junction temperature

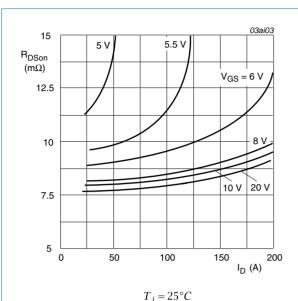


Fig 9. Drain-source on-state resistance as a function of drain current; typical values

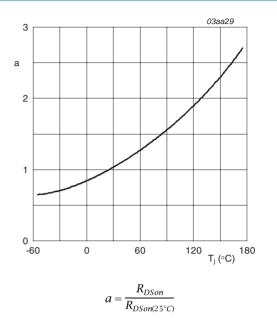


Fig 10. Normalized drain-source on-state resistance factor as a function of junction temperature

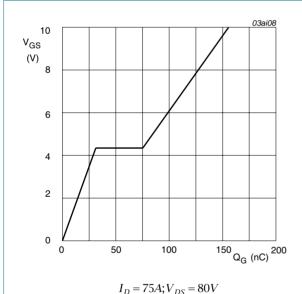
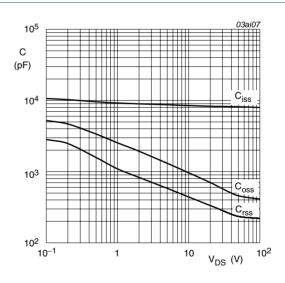


Fig 11. Gate-source voltage as a function of gate charge; typical values

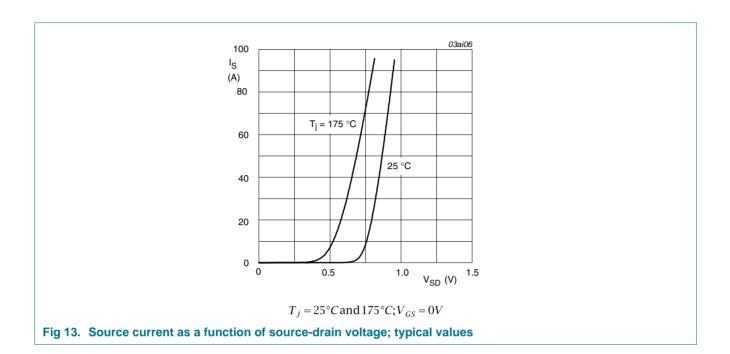


 $V_{GS} = 0V; f = 1MHz$

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

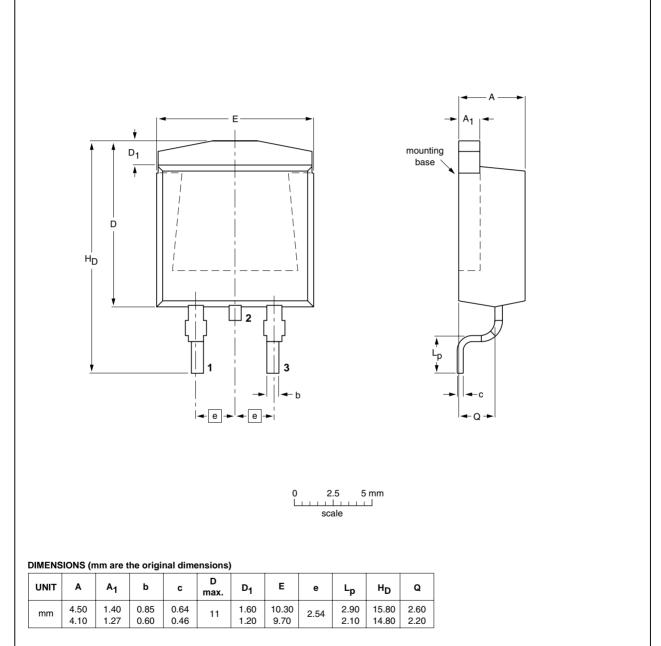
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7. Package outline

Plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped) SOT404



| OUTLINE | | REFER | RENCES | EUROPEAN | ISSUE DATE |
|---------|-----|-------|--------|------------|--------------------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE |
| SOT404 | | | | | -05-02-11 |

Fig 14. Package outline SOT404 (D2PAK)

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8. Revision history

Table 7. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------------|--------------------------------|----------------------------------------------------|-------------------------|----------------------------|
| PSMN009-100B_2 | 20090706 | Product data sheet | - | PSMN009_100P_100B-01 |
| Modifications: | | at of this data sheet has s of NXP Semiconducto | • | mply with the new identity |
| | Legal text | s have been adapted t | o the new company nan | ne where appropriate. |
| | Type num | ber PSMN009-100B s | eparated from data shee | et PSMN009_100P_100B-01. |
| PSMN009_100P_100B-01 | 20020429 | Product data | - | - |

9. Legal information

9.1 Data sheet status

| Document status [1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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